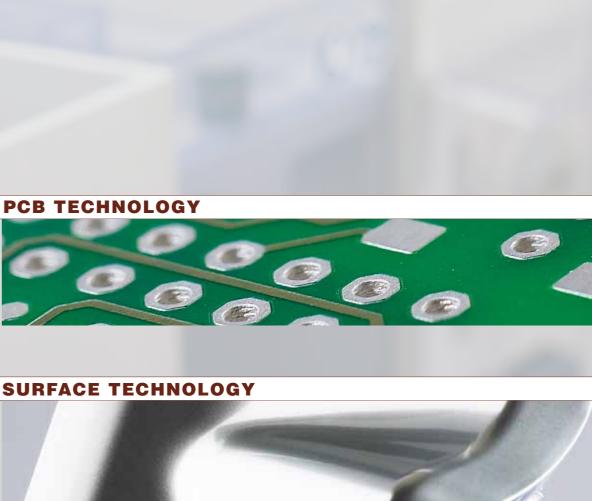
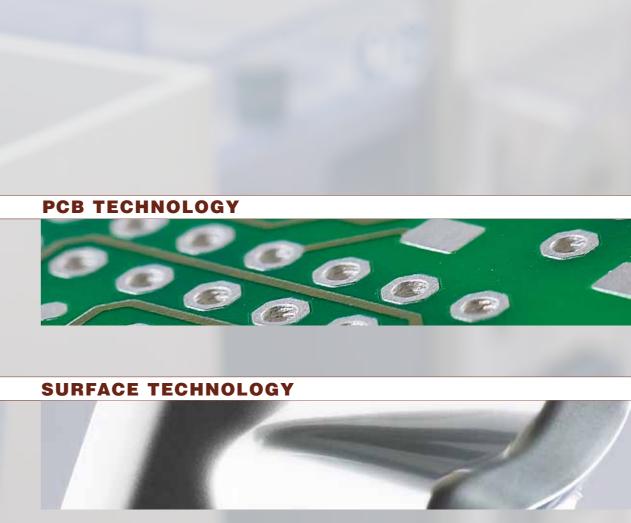
## **Precision in detail**



English version









#### PRECISION

#### **Over 40 years of experience and passion**

For over 40 years the Walter Lemmen Ltd. has been producing an extensive selection of products, for the surface and printed circuit board technology for industry, research and teaching. The different facilities are constructed and manufactured in our factory in Kreuzwertheim and distributed worldwide. The product range includes machines and equipment for the production of single or double-sided PCBs, through hole plated PCBs and multilayers for prototypes and small serial production.

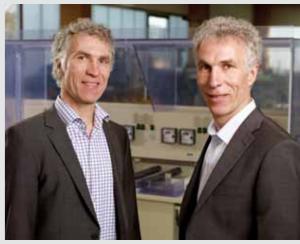
Barrel and rack treatments are individually adapted to customer requirements for electroplating and finishing of different materials. These applications are used for decorative and functional surfaces to complement the portfolio. The outstanding results can be seen in exceptional quality materials and components thereby guaranteeing a low maintenance operation.



Walter Lemmen Ltd ment, design and o printed circuit boar Additionally, the co vice program, cons systems, compone mental concepts fo Our main customer industry, the electr communications an tems, the medical t

The company has a close cooperation with different institutions in research and development. The basis for innovative implementations and enhancements of our plant diversity, is found in colleges, universities and in several industries and used to support new technologies in the printed circuit board technology and electroplating.





Walter Lemmen Ltd. offers as a system supplier, the development, design and construction of equipment and systems for printed circuit boards and electroplating.

Additionally, the company offers a complete product and service program, consisting of the delivery of customer-specific systems, components and chemistry, service and environmental concepts for various industrial branches.

Our main customers include the PCB industry, the automotive industry, the electronics industries, the aerospace, the telecommunications and management industry, the control systems, the medical technology and the photovoltaics industry.

### **PCB TECHNOLOGY**

### Equipment for the manufacture of printed circuit boards

#### **PCB** technologies:

- One and double sided PCBs
- Through hole plated PCBs
- · Multilayer up to max. 6 layers
- RF circuit boards
- LTCC Ceramic
- MID-Wafer Technology
- HDI Micro via Technology
- Flex and Flex-rigid Board Technology
- Thick Copper Board Technology
- Insulated Metal Substrate (IMS-Board Technology)
- · Structuring of non-ferrous metals, stainless steel and aluminum front panels and labels

#### **PCB** materials:

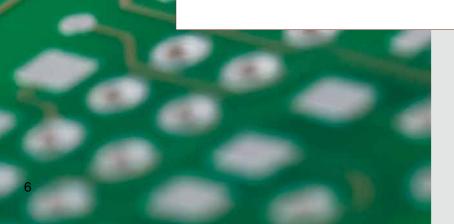
- Photo-coated base material FR4 / FR2 / CEM1 / PTFE
- Photo-plated SMD stencil sheets
- Base material for special applications
- Front panel material ALUCOREX
- · Photo-coated anodized aluminum
- Flexible Substrates
- Rigid-Flex Substrates

The demand for finer and more complex structures, small components and flexible materials is growing rapidly. As a result, the company is expected to be fast and flexible in implementing the new technologies with available highquality equipment.

The Walter Lemmen Ltd. has a perfectly matched equipment program. It covers the entire manufacturing process to produce high quality printed circuit boards with complex structures. Additionally it covers fine conductor plates, widths and distances on different base materials.

The product lines from the Walter Lemmen Ltd. ranges from systems for structuring, surface treatment and through hole plated systems. Surface facilities for the protection of one and double sided printed circuit boards, chemical milled parts and multilayer are also included.

Our product range is complemented by environmentally friendly production technologies. This includes a high level of safety standards, reduction of environmental pollution, lower consumption of raw materials, chemicals, energy and water. Integrated rinsing and filtration technology, regeneration equipment, waste water treatment plants and electrolytic cells used for the complete recovery of precious metals from the rinse water process are reflected in our products.





#### Equipment for the manufacture of printed circuit boards

#### Film processing • Exposure • Lamination



Inexpensive and very effective devices are available for the technical film processing procedure especially for the production of prototypes. This ranges from photoplotters for the production of high-quality films for subsequent processes, to one and double-sided working UV exposure units. The professional design of the photoplotters allow the processing of standard CAD data, which guarantee an optimal film exposure result on the UV exposure systems. They are available in different sizes and designs. A special UV technology in combination with a drawer vacuum system and a wide range of device equipment, ensure an optimal exposure result and short exposure times.

#### **Brushing • Cutting • Drilling**

A wide product range of manual and motorized sheet shears are available, for cutting of circuit boards, metal sheets and aluminum. The different device models provide the perfect cut and accurate edges. For professional drilling and routing of circuit boards, metal parts, plastic and front panels, we offer manually operated precision drilling machines. They are specifically designed for the prototype production, which guarantee a high level of drilling quality and usability.

Our CNC controlled drilling and milling machines with manual or automatic tool changer works with high accuracy, resolution and step drilling frequency. The stable aluminum construction allows for processing multiple panels and can also be used for isolation routing of circuit boards and aluminum front panels.

The high quality UV-LED direct imagine system (UV-P50) is the ideal solution for a fast, accurate and robust prototyping of printed circuit boards and etched parts. It exposes all standard UV sensitive materials, such as negative dry resist, positive resist or solder mask. The UV-LED direct imagine system (UV-P50) exposes the layout in a short time and without any mask. There are already provided for in the basic-version resolution of 75µm line width and spacing.



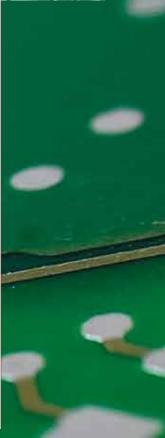
Our powerful laminators can be used for the processing of all usual photostructurable laminates and photopolymer film (solder mask), printed circuit board production and chemical milled parts production. The laminators ensure an optimum lamination result. Lemmen's compact brushing machines can be used universally for different materials and substrates include laminating or deburring, after drilling in the print production. Special devices of single or double-sided working table units or floor units are also available.



The machines through its easy handling and stable construction have a wide scope in the mechanical circuit board processing. Which combines the adjustable transport speed and the modulation oscillator devices.







Equipment for the manufacture of printed circuit boards

- IC I I M

#### **Developing • Etching • Rinsing • Stripping**

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The modular designed etching and developing devices of Lemmen Ltd., allow for fast processing of printed circuit boards in the spray-etching and development process, foam-etching process or continuous spray-etching process. This provides the perfect premise for a high-quality printed circuit board image.

Special holders allow the customer to edit different PCB materials in the manual or vertical method of process running. The floor-mounted or table units in a compact construction include all process steps from develo-



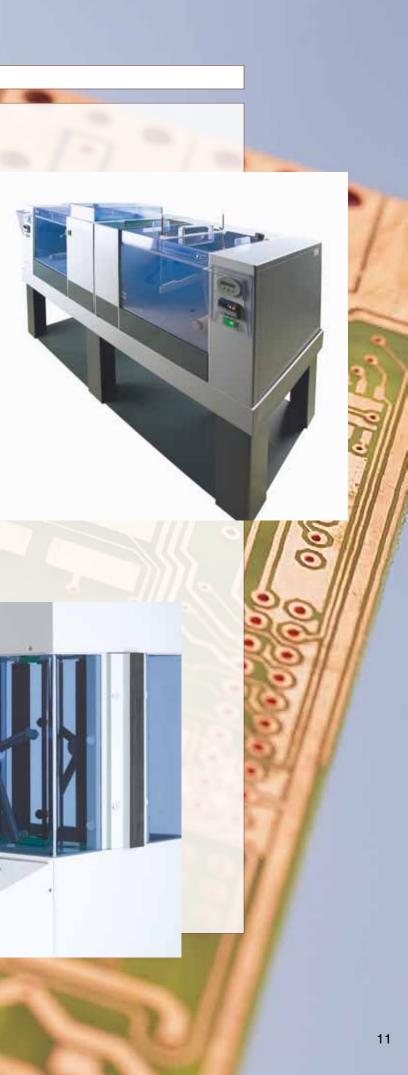
ping, etching and rinsing (optional stripping) in one unit and enable the production of highquality PCB structures of 50-100 microns. The units are designed for prototypes and small series of up to a suitable plate size of 500 x 600 mm.

The spray development and spray etching units, ETCHING CENTER S and CONVERT from Lemmen Ltd., are suitable for the production of fineline single or double-sided printed circuit boards or chemical milled parts. The systems are available either manually or vertically, which are operating systems with integrated rinsing moduls. Our new rotation spray systems give uniformity and intensive treatment to the entire surface. The units are equipped with multiple rinses which is characterized by their clean and compact way of working. The modular design allows expansion of the units by a stripper and dryer module.

The laboratory bench systems of series MINISTAR and the floor-mounted units of the series ETCHING CENTER V are used for developing, etching and rinsing in foametching process and continuous development process. They are ideal for the processing of small printed circuit boards and etched plates in laboratories, schools and institutions to create professional sample sheets and prototypes.







#### Through hole plated and multilayer

#### Through hole plated technology

The creation of high-quality printed circuit boards and multilayers require high precision and systems engineering for the metallization of the holes, soldering of the contacts and finishing, which protects against oxidation and corrosion.

To create the through-hole plated printed circuit boards, the PCBs must be pretreated by a wet chemical process, by metallizing the substrate inside the hole and therby establishing connection between the individual layers.

For the through-hole plating galvanic process we offer our range COMPACTA,



as a general-purpose electroplating plant, for the chemical or electrochemical treatment of metals in vertical technology. In consultation with the customers requirements the desired through-hole plating system is constructed.

The general production of high quality through-hole printed circuit boards, is based on an evironmentally friendly direct metallizing with graphit as catalyzer, in tenting or subtractive process.

#### **Multilayer**

To achieve the high volume of information on a printed circuit board, using the smallest space, the multilayer production is considered. Here several boards are pressed together with prepregs.

The compact multilayer press allows the compression of 6-8 multilayer boards. The optimal pressure distribution and temperature, guarantees uniformity of the compression for the individual layers. In combination with the exposure, development, etching and through-hole plated units, high-quality multilayers can be manufactured in a short period of time.

The modular design of the systems provides the ability to integrate additional processes into the system concept: desmearing, blackening, tin stripping,

resist stripping, immersion tin and organic protective coating (OSP), immersion nickel / gold, immersion silver, electroplated nickel / gold.

The treatment and rinsing tanks are optimally fitted with highquality facilities and system components which guarantee an optimal result for printed circuit board.





#### Surface finishing of printed circuit boards

#### **Final Finishes • protective layers**

Organic, chemical or galvanic protective coatings are used for oxidation and corrosion protection of PCB surface finishes.

A high quality surface finish on PCBs is guaranteed through the use of special equipment in combination with chemical processes. The final surface treatment of different PCB types can be integrated as an additional process, eg. in the COMPACTA



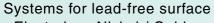
device or as a single unit in the series PROTEC. The system configuration depends on different chemical treatments for the surface protection of the respective processes:

### **Drying** • Tempern

The printed circuit board process dryer is designed in a vertical position. This pro-



vides a rapid residue-free drying of PCBs, chemical milled parts, non-ferrous metals or other etched substrates by the wet chemical process. The circuit board is automatically transported through the drying zone and is the subsequent processing step of laminating and quick surface treatment. The program is expanded by the universal use of ovens for drying, tempering and heating circuit boards and substrates. The quality of the stainless steel ovens offer a variety of facilities and program function. The application-specific options are easy to use and ensure a wide range of applications.



- Electroless Nickel / Gold
- Immersion Tin
- Immersion Silver
- Organic surface protection (OSP)

Equipment for special applications

- Galvanic Nickel / Gold
- Galvanic Silver



#### Waste water treatment

Special filters and water treatment technology ensure a clean water process. Besides a large selection of filters, we offer solid ion-exchange systems in the series IONEX that allows for continuous cleaning and reuse of rinse water from rinsing baths and sinks savings. This contributes to an increase in the circulation of water quality and substantial water savings.

The waste water treatment is designed as a circulation or flow-through system. The circulatory system is cleaned, and this filtered water is than returned to the plant for reuse.

Through the use of special ion-exchange resins precious metals (gold, silver, rhodium, palladium) can be recovered from the rinse water. The recovery of ion exchange resins is offered as a service and is therefore an economic solution in the waste water treatment process.

#### **ELECTROPLATING**

### **Product range:**

Tank volume: 5 liters - 100 liters (other volumes on request)

Design: Manual rack and barrel treatments Automatic handling systems on request

Units for pre-treatment: Pre-cleaning Degreasing

Systems for decorative surface treatment: Gold Silver Rhodium

Chrome

Ultrasonic

Systems for functional surface treatment: Copper Tin Zinc

Electropolishing

Systems for anodization and coloring treatments Anodization Titanium coloring

#### Installations for surface treatment

#### **Decorative and functional surface treatment for rack** and barrel treatment

With our extensive knowledge and wide product range, we offer high productive systems in the field of surface technology and finishing. Our system covers an entire range for proces- 🌌 sing of the most diverse materials for decorative and functional surface coating. This includes cleaning, coating and finishing of barrel and rack treatment of plastics, steel, 1 aluminum and titanium or other metals. Customer-oriented concepts matched with the respective chemical processes and reliable services complement the portfolio. As a competent partner for the PCB and electronics industry as well as the automotive, sanitary, jewelry and consumer goods industry, we pursuit a high quality standard and reliability in corrosive resistant surface.



#### Surface technology

#### **Pre-Treatment**



Through the pre-treatment of the coated materials a high quality surface is guaranteed. These pre-treated units for barrel or rack treatments are fitted with a pre treatment tank for degreasing and rinsing cascades. Optional items like exhaust tubes and suction heads provide a clean work environment.

#### **Anodization and coloring treatment**

Small galvanic units or single tanks for anodizing of light metals are used for surface treatment of parts made of pure titanium or titanium alloys and aluminum. The facility includes all pre-treatment and post-treatment processes for optimum anodic oxidation to generate adherent surface layers in decorative colors.

### **Decorative and functional surfaces**

In the field of decorative and functional surfaces, we offer a wide range of plants and plant technology for all surfaces, including chemicals and services. Together with the customer and the use of up to date electroplating technology, we develop multifunctional units for coating of metal substrates or plastic materials. Our product range includes all plant varieties for decorative and functional surfaces. This includes the pre-treatment and surface preparation, corrosion protection of components up to decorative surface finishing for jewelry, sanitary products or consumer goods.



#### **Automatic placement**

Specific plants can be equipped with pneumatic handling system and Siemens S7 controller.







### ELECTROPLATING

#### **Product range:**

- Electroplating systems for the standard sizes of 1,5 3,0 liter tank volume
- Electroplating table units for the standard sizes from 5 50 liter tank volume
- Small electroplating plants as barrel or rack systems for the standard sizes from 5 100 liters of tank volume
- Metal recovery modules for precious metals
- Waste water treatments for precious metals
- Pickling
- Stripper systems for precious metals
- Developing and etching equipment for structuring stainless steel and nonferrous metals
- Accessories for electroplating

#### **Small electroplating systems for surface treatment**

## Small electroplating systems for decorative and functional surfaces

In addition to our small electroplating plants, we offer a universal program for small appliances for functional and decorative surfaces with small bath volumes. These multifunctional devices and systems from 1,5 liter tank volume are suitable for the jewelry-industry, medical and industrial manufacturing of small parts. Through a variety of different bath components, such as heaters, rectifiers, barrels, racks, filters and ion exchange equipments, the units offer the optimum surface condition for a professional result.



#### **Small equipment for surface treatment**

#### **Small electroplating machines**

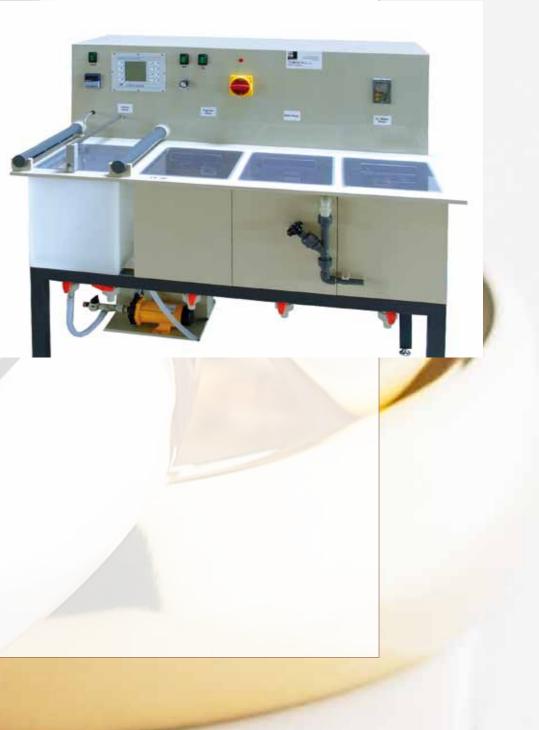


The modular electroplating system is a high performance system for jewelers, watchmakers, research and development engineers and for laboratories in craft and industry. A multi-functional rectifier combined with different tank holders which have 1,5 liter and 3,0 liter tank capacity, and electrolytes, provide the basis for professional results in electroplating surface technology. The complete system with integrated heating and agitation can be used for the electrolytic degreasing and all precious metal plating electrolytes.

# Compact small electroplating plants for decorative surfaces and machines for degreasing

The small compact electroplating facility in standard sizes of 5, 10 and 20 liter tank volume, are small electroplating machines for decorative surfaces such as gold, silver and rhodium. Additional modules for pre-treatment complement the

series of devices. The plant design includes all necessary installation components such as rectifiers with Ah-counter, agitation, air injection and cooling which results in a highquality decorative surface.



### **TG- Electroplating Equipment - Table units**

The TG-Electroplating systems have a standard tank volume of 5 I / 10 I / 20 I and 50 I, allows the individual assembly of treatment tanks. The TG-Electroplating system can be converted into an electroplating tank, by using conversion kit E or in a cleaning tank with air agitation by using conversion kit S. Additional options, such as agitation for movement, rectifiers, floor heaters with temperature controllers and barrels equipment allows reliable surface treatment for various applications.

22



#### **Titanium coloring units**

The titanium-color system was developed especifically for surface treatment of parts made of pure titanium or titanium alloys. Anodic oxidation can produce different colors, uniformity and adherent surface layers. The parts to be coated are oxidized in the ready-used titanium-color electrolyte, and thereafter in a special anodic pre- treatment for titanium pickling. By varying the bath voltage through



the adjustment of the artificially produced oxide layer, a variety of decorative colors can be generated. The multifunctional properties of titanium and titanium alloys, is the prefered choice in the medical, aerospace and chemical industries.

### **Pickling and Stripping units**

Pickling unit:

The pickling unit is suitable for stripping of precious metal parts and castings. The treatment unit is equipped with a heated pickling bath which is then followed by the rinsing procedure. Additionally, the acid-resistant exhaust fume with fan and security tank, which is optional, guarantee the safety aspect of a clean environment.

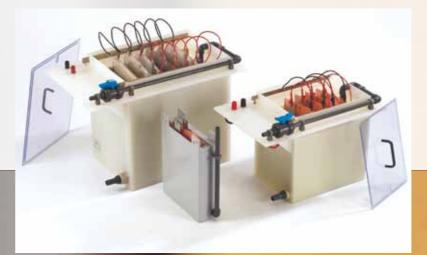
Stripping unit with metal recovery systems:

This system enables optimum stripping of precious metals on coated components. The recovery of precious metals takes place in a special electrolytic cell, which is built in several stages. The system concept guarantees a high deposition rate of gold, silver, rhodium or palladium from rinse water and concentrates.



We offer specially designed modules for the economical recovery of various metals, gold, silver, palladium, platinum etc., and base materials from rinse water and concentrates.

We have in our portfolio different metal recovery modules, which can be used for the direct operation in the rinsing tank or as external bypass-units.















Walter Lemmen GmbH Birkenstraße 13 D-97892 Kreuzwertheim Germany

Tel: +49 (0) 93 42 / 78 51 Fax: +49 (0) 93 42 / 2 11 56 info@walterlemmen.de www.walterlemmen.de